

Thermoelectric Property of Silicon Nanowires Processed by Metal Assisted Directional Chemical Etching

David Rodriguez and Yong X. Gan (Department of Mechanical Engineering, California State Polytechnic University Pomona, 3801 W Temple Avenue, Pomona, CA 91768, USA)

Objectives

- ◇ To prepared silicon single crystal nanofibers using a silver induced self-catalysis chemical etching process
- ◇ To test the thermoelectric property of the silicon nanofiber

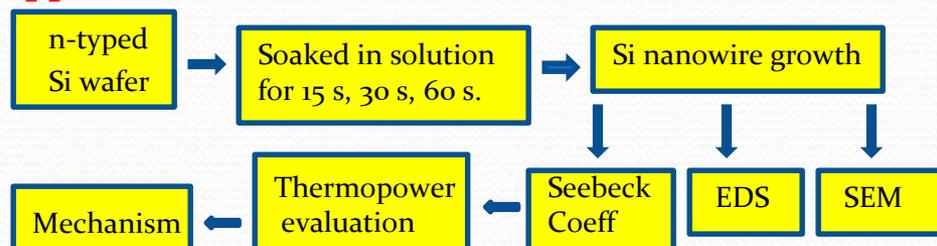
Background

- ◇ Thermoelectric (TE) materials offer the opportunity for direct conversion of heat into electrical power from temperature differences.
- ◇ Semiconducting materials are often used in TE units because they have high power factors.
- ◇ Silicon has been extensively studied because of the relatively low cost and high figure of merit.
- ◇ Si is compatible with oxide/metallic connecting electrode materials.
- ◇ Nanostructured Si in the form of thin film or nanowire (NW) has higher energy conversion efficiency than bulk silicon.
- ◇ Si NW is often processed by E-beam lithography and chemical vapor deposition (CVD); self-catalysis chemical etching is a new process.

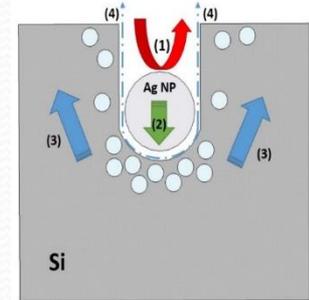
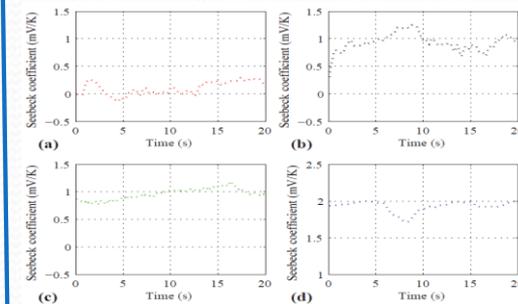
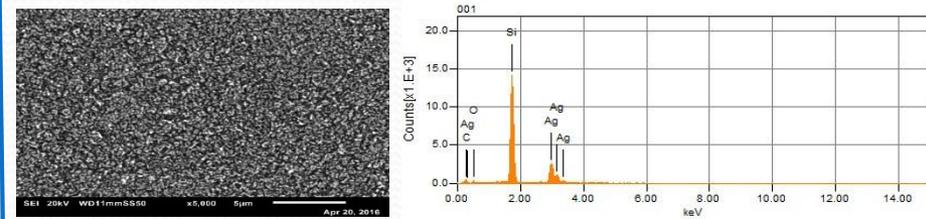
Materials and Instruments

- ◇ <100> n-type Si wafer pieces with the thickness of 500 micron
- ◇ Solution: 0.01 M AgNO₃, 0.2 M H₂O₂ and 4.8 M HF
- ◇ CHI 440C electrochemical workstation for measuring TE property
- ◇ Jeol JSM-6010PLUS/LA SEM with energy dispersive X-ray spectroscopy

Approaches



Results and Discussion



Conclusions

- ◇ SiNWs were successfully synthesized by first depositing Ag NPs onto n-type Si wafer and secondly implementing the MaCE technique.
- ◇ The Seebeck coefficient of the SiNWs is three times higher than that of the original Si wafer.
- ◇ The SiNW with thermoelectric performance improvement is promising for the next generational thermoelectric devices.

Acknowledgements

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